Z0103NA

Logic level four-quadrant triac Rev. 03 — 5 August 2009

Product data sheet

Product profile 1.

1.1 General description

Passivated sensitive gate 4-Q triac in a SOT54 plastic package

1.2 Features and benefits

- Direct interfacing to logic level ICs
- Direct interfacing to low power gate drive circuits
- High blocking voltage of 800V
- Sensitive gate in four quadrants

1.3 Applications

- General purpose low power motor control
- Home appliances

- Industrial process control
- Low power AC Fan controllers

1.4 Quick reference data

Table 1. **Quick reference**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{DRM}	repetitive peak off-state voltage		-	-	800	V
I _{T(RMS)}	RMS on-state current	full sine wave; T _{lead} ≤ 38 °C; see <u>Figure 1</u> and <u>4</u>	-	-	1	А
I _{TSM}	non-repetitive peak on-state current	full sine wave; $t_p = 20 \text{ ms}$; $T_{j(init)} = 25 \text{ °C}$; see Figure 2 and 3	-	-	8	Α
		full sine wave; $t_p = 16.7 \text{ ms}$; $T_{j(init)} = 25 \text{ °C}$	-	-	8.5	А
Static ch	aracteristics					
I _{GT}	gate trigger current	$V_D = 12 \text{ V; } T_j = 25 \text{ °C;}$ T2+ G-; see Figure 6	-	-	3	mA
		V _D = 12 V; T _j = 25 °C; T2- G-	-	-	3	mA
		V _D = 12 V; T _j = 25 °C; T2+ G+	-	-	3	mA
		V _D = 12 V; T _j = 25 °C; T2- G+	-	-	5	mA



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2. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	T2	main terminal 2	,	N.1
2	G	gate		T2 T1
3	T1			sym051
			SOT54 (TO-92)	

3. Ordering information

Table 3. Ordering information

Type number	Package			
	Name	Description	Version	
Z0103NA	TO-92	plastic single-ended leaded (through hole) package; 3 leads	SOT54	

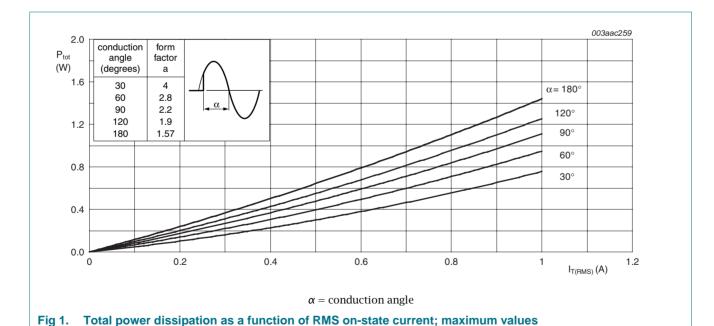
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4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

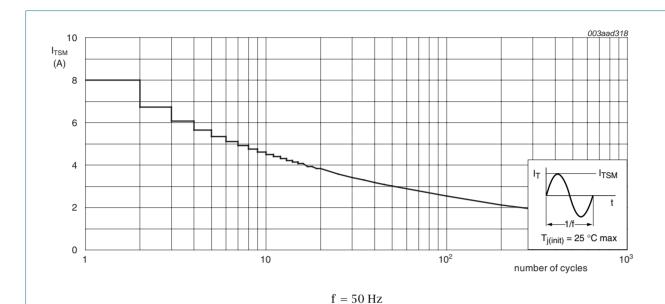
Symbol	Parameter	Conditions	Min	Max	Unit
V_{DRM}	repetitive peak off-state voltage		-	800	V
I _{T(RMS)}	RMS on-state current	full sine wave; T _{lead} ≤ 38 °C; see <u>Figure 1</u> and <u>4</u>	-	1	Α
dI _T /dt	rate of rise of on-state	$I_T = 1 \text{ A}$; $I_G = 20 \text{ mA}$; $dI_G/dt = 100 \text{ mA/}\mu\text{s}$; $T2 + G + G$	-	50	A/µs
	current	$I_T = 1 \text{ A}$; $I_G = 20 \text{ mA}$; $dI_G/dt = 100 \text{ mA/}\mu\text{s}$; $T2 + G$	-	50	A/µs
		$I_T = 1 \text{ A}$; $I_G = 20 \text{ mA}$; $dI_G/dt = 100 \text{ mA/}\mu\text{s}$; T2- G-	-	50	A/µs
		$I_T = 1 \text{ A}$; $I_G = 20 \text{ mA}$; $dI_G/dt = 100 \text{ mA/}\mu\text{s}$; T2- G+	-	20	A/µs
I _{GM}	peak gate current		-	1	Α
P_{GM}	peak gate power		-	2	W
T _{stg}	storage temperature		-40	150	°C
Tj	junction temperature		-	125	°C
I _{TSM}	non-repetitive peak on-state current	full sine wave; $t_p = 20$ ms; $T_{j(init)} = 25$ °C; see Figure 2 and 3	-	8	Α
		full sine wave; $t_p = 16.7 \text{ ms}$; $T_{j(init)} = 25 \text{ °C}$	-	8.5	Α
I ² t	I ² t for fusing	t _p = 10 ms; sine-wave pulse	-	0.32	A ² s
P _{G(AV)}	average gate power		-	0.1	W



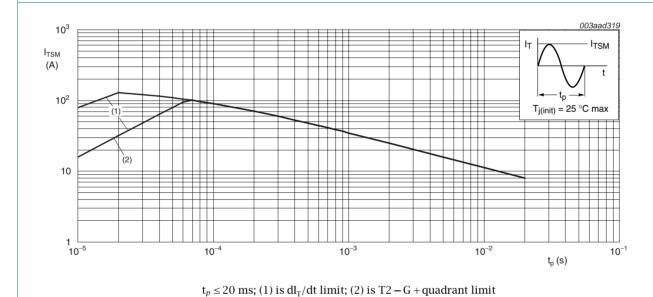
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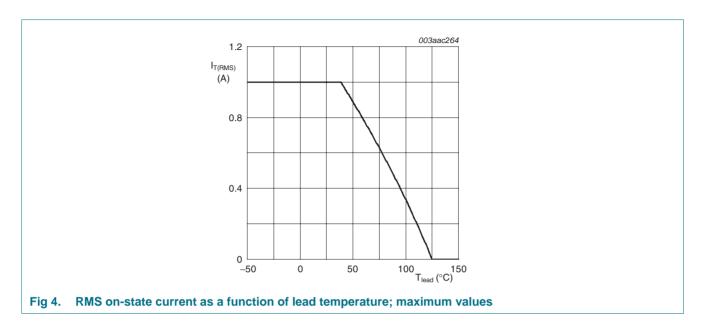
Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum Fig 2. values



Non-repetitive peak on-state current as a function of pulse width; maximum values Fig 3.

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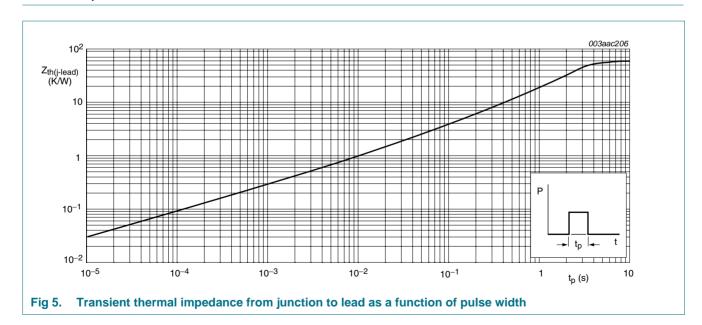
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5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient		-	150	-	K/W
$R_{\text{th(j-lead)}}$	thermal resistance from junction to lead	Full cycle; see Figure 5	-	-	60	K/W



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6. Characteristics

Table 6. Characteristics

Table 0.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
I _{GT}	gate trigger current	$V_D = 12 \text{ V; } T_j = 25 \text{ °C; } T2+ \text{ G-;}$ see Figure 6	-	-	3	mA
		V _D = 12 V; T _j = 25 °C; T2- G-	-	-	3	mΑ
		$V_D = 12 \text{ V}; T_j = 25 \text{ °C}; T2+ G+$	-	-	3	mΑ
		$V_D = 12 \text{ V}; T_j = 25 \text{ °C}; T2-G+$	-	-	5	mΑ
IL	latching current	$V_D = 12 \text{ V; T}_j = 25 \text{ °C; I}_G = 0.1 \text{ A; T2+ G-;}$ see Figure 7	-	-	7	mA
		$V_D = 12 \text{ V}; T_j = 25 \text{ °C}; I_G = 0.1 \text{ A}; T2+ G+$	-	-	7	mΑ
		$V_D = 12 \text{ V}; T_j = 25 \text{ °C}; I_G = 0.1 \text{ A}; T2- G+$	-	-	7	mΑ
		$V_D = 12 \text{ V}; T_j = 25 \text{ °C}; I_G = 0.1 \text{ A}; T2-G-$	-	-	7	mΑ
l _H	holding current	$V_D = 12 \text{ V; } T_j = 25 \text{ °C; see } \frac{\text{Figure 10}}{\text{ or } T_j}$	-	-	7	mΑ
V_{T}	on-state voltage	I _T = 1 A; see <u>Figure 8</u>	-	1.3	1.6	V
V_{GT}	gate trigger voltage	$I_T = 0.1 \text{ A}; V_D = 12 \text{ V}; T_j = 25 \text{ °C};$ see <u>Figure 9</u>	-	-	1.3	V
		$I_T = 0.1 \text{ A}; V_D = 800 \text{ V}; T_j = 125 ^{\circ}\text{C}$	0.2	-	-	V
D	off-state current	V _D = 800 V; T _j = 125 °C	-	-	0.5	mΑ
Dynamics	charateristics					
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 536 V; T_j = 110 °C; gate open circuit; see Figure 11	10	-	-	V/µs
dV _{com} /dt	rate of rise of commutating voltage	$V_D = 400 \text{ V}; T_j = 110 \text{ °C};$ $dI_{com}/dt = 0.44 \text{ A/ms}; \text{ gate open circuit}$	0.5	-	-	V/µs

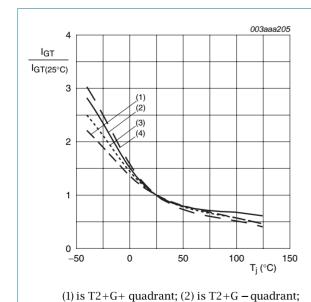


Fig 6. Normalized gate trigger current as a function of junction temperature

(3) is T2 - G – quadrant; (4) is T2 - G + quadrant

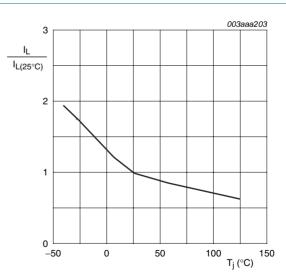


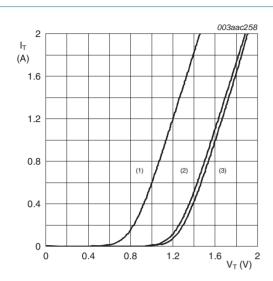
Fig 7. Normalized latching current as a function of junction temperature

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 $\begin{aligned} &\mathbf{V}_0 = 1.254 \; \mathbf{V}; \mathbf{R}_{\mathrm{s}} = 0.31 \, \Omega \\ &(1) \; T_j = 125 \; \mathbf{C}; \; \text{typical values} \\ &(2) \; T_j = 125 \; \mathbf{^{\circ}C}; \; \text{maximum values} \\ &(3) \; T_j = 25 \; \mathbf{^{\circ}C}; \; \text{maximum values} \end{aligned}$

Fig 8. On-state current as a function of on-state voltage

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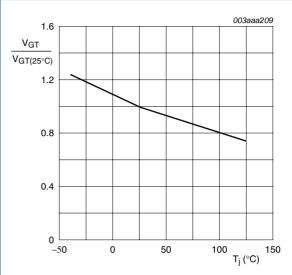


Fig 9. Normalized gate trigger voltage as a function of junction temperature

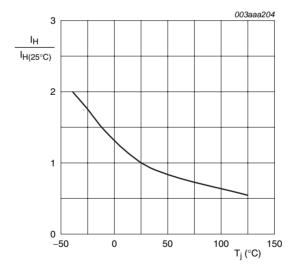


Fig 10. Normalized holding current as a function of junction temperature

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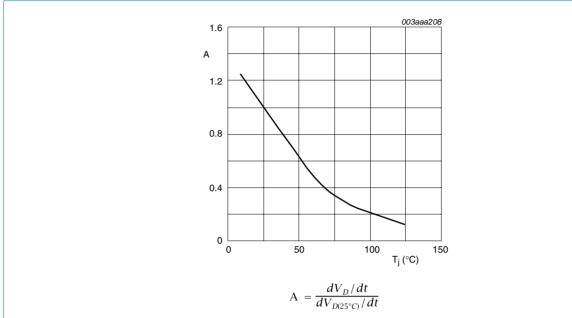


Fig 11. Normalized critical rate of rise of off-state voltage as a function of junction temperature;typical values

7. Package outline

Plastic single-ended leaded (through hole) package; 3 leads

SOT54

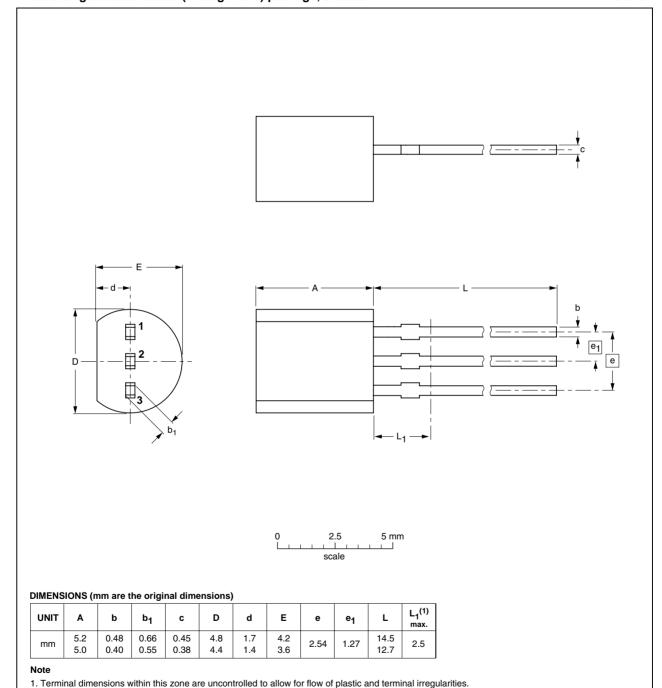


Fig 12. Package outline SOT54 (TO-92)

IEC

OUTLINE

VERSION

SOT54

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JEITA

SC-43A

EUROPEAN

PROJECTION

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ISSUE DATE

04-06-28

04-11-16

REFERENCES

JEDEC

TO-92

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8. Revision history

Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
Z0103NA_3	20090805	Product data sheet	-	Z0103_07_09_SERIES-02
Modifications:	guidelines	of this data sheet has bee of NXP Semiconductors. have been adapted to the	· ·	mply with the new identity ne where appropriate.
	 Type numb 	er Z0103NA separated fro	om data sheet Z010	3_07_09_SERIES-02.
Z0103_07_09_SERIES-02 (9397 750 10102)	20020912	Product data	-	Z0103_07_09_SERIES-01
Z0103_07_09_SERIES-01 (9397 750 09419)	20020411	Product data	-	-

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Document status [1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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